



# MECHANICAL & INDUSTRIAL CERAMICS

# **KYOCERA ENGINEERING CERAMICS**

Today, at the dawn of the 21st century, materials are continually being developed and improved, blending a wide spectrum of technologies. The most exciting evolution of all materials, however, is occurring in engineering ceramics.

In Kyocera's advanced manufacturing of fine ceramics, it is possible to bring forth ceramics maximum performance.

Kyocera's fine ceramic products are widely used in industrial machines and electronic equipment and devices. The superior electrical characteristics of fine ceramics are utilized in a variety of circuit boards and electronic parts. Their wear and corrosion resistance is beneficial in pumps, nozzles and valve parts, and their high heat and thermal shock resistance is useful in ceramic engine parts.

Based on its advanced ceramics technology, Kyocera put into practical use its ultra-precision processing technology in the manufacturing of OA equipment parts and fiber optic connectors where high precision is required. The applications of fine ceramics continue to expand, from single to multiconponent products such as air slides and X-Y tables.

Kyocera, with its highly sophisticated technology and expanding capacity, is determined to disseminate fine ceramics into every corner of industry. It is dedicated to enhancing human productivity, cultivating the future of tomorrow's technological society.



**Alumina** 



Sili

Silicon Nitride

02



con Carbide



Zirconia

# **UNRIVALED R&D**

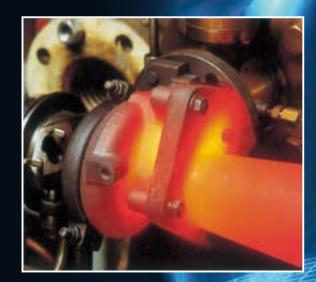
In today's information society, marketing research and technical development capacities hold the key to the future of an enterprise. In order to accurately meet client needs, Kyocera established an integral R&D organization. Performing stringent quality control over every detail of the manufacturing process.

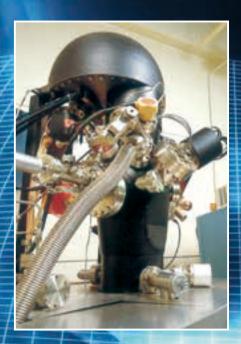
In developing new products, Kyocera's R&D operations are centralized in the General Research Institute. They conduct thorough studies to continually enhance and develop materials and manufacturing techniques. The engineering and business divisions perform commercialization, repeating product reliability tests until complete confidence is reached.

Under supervisors with a strong sense of responsibility, everyone, from development to manufacturing, conducts thorough product control, so that highly reliable, high performance products will be delivered.

Using the best combination of materials and technologies available, Kyocera promotes flexibility to meet the diversified industry needs with is ultimate goal to produce superior products.









# **ASSEMBLY PRODUCTS**

# AUTOMOTIVE PARTS

### • Gas turbine parts

The gas turbine, clean in energy consumption and superior in thermal efficiency is being heralded as the leading engine for the 21st century. The development and commercialization of engineering ceramics, which can withstand severe conditions such as high temperatures and heavy loads, holds the key to the success of the gas turbine engine.



### **Engine parts**

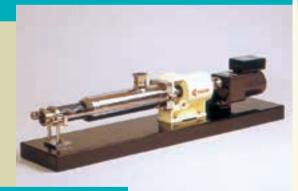
Triggered by the commercialization of the ceramic glow plug, the application of ceramics to engine parts has increased due to ceramics superior heat resistance and high temperature strength.



## PUMP PRODUCTS

### Progressive cavity pump

The pump's rotor and stator consist of wear and heat resistant ceramics in order to transport high temperature liquids, slurry fluids and foods.



### Ceramic centrifugal pump

In this type of pump, all liquidcontact parts are made of 99.5% pure alumina, which is best suited for the transportation of chemical liquids, orgainc solvents and slurry fluids.



### Air slide

Air slides, for X-Y tables and measuring units, are manufactured using Kyocera's advanced processing technology, creating unprecedented high precision and reliability.



# PRECISION UNIT PRODUCTS



In the high-tech industry, there is a demand for light-weight air spindles Kyocera's ceramic air spindles are used in rotary tables or, coupled with a motor to form turning units. These applications benefit from ceramics high rigidity and superior rotational precision.

### X-Y table

X-Y tables benefit from the ceramic air slides high precision, simple maintenance and non-magnetism. X-Y tables are used in semiconductor manufacturing equipment, precision measuring instruments, and high precision processing machines.





# **CERAMIC PRODUCTS**



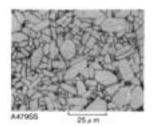


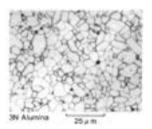
# **TYPES OF CERAMICS**

With sintered alumina as a base, many other types of ceramic materials have been developed. These fine ceramics are classified according to their use, specifically functional materials (electroceramics) and structural materials (engineering ceramics). As the pioneer in the fine ceramics materials revolution, Kyocera continually develops and provides the most advanced ceramics.

### **ALUMINA CERAMICS (AI<sub>2</sub>O<sub>3</sub>)**

Alumina is the most widely used type of ceramic. Its high dielectric properties are beneficial in electrical products, Alumina offers corrosion and wear resistance and high strength. It is widely used for industrial machine parts.

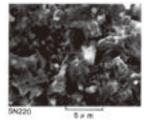




### SILICON NITRIDE CERAMICS (Si<sub>3</sub>N<sub>4</sub>)

Silicon nitride exceeds other ceramics in thermal shock resistance. Its strength does not deteriorate at ele-

vated temperatures, hence it is most appropriate for engine and gas turbine parts, including turbo charger rotors, diesel engine glow plugs and hot plugs.



### **MULLITE CERAMICS (3AI<sub>2</sub>O<sub>3</sub>, 2SiO<sub>2</sub>)**

Mullite has a low thermal expansion coefficient and is used in parts requiring heat and thermal shock resistance, such as burner nozzles and tiles.

### **TITANIA CERAMICS**

Titania excels in surface smoothness and wear resistance. By the addition of CaO or BaO titania, the materials conductivity allows it to be used in static free applications such as guides and sliders.

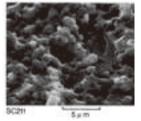
### **■CERMET (TiC, TiN)**

By the addition of metal components such as cobalt, nickel, or molybdenum, composite ceramics knows as cermets are formulated.

### **SILICON CARBIDE CERAMIC (SiC)**

Silicon carbide retains its strength at elevated temperatures as high as 1400°C. It has the highest corrosion resistance of all fine ceramic materials. Applications

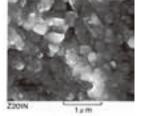
include mechanical seals and pump parts.



### **ZIRCONIA CERAMICS (ZrO<sub>2</sub>)**

Zirconia ceramic has the highest strength and toughness at room temperature of all engineering ceramics.

Before zirconia, ceramics were considered impractical for scissor or knife applications. With its excellent surface smoothness, zirconia is also used for pump parts.



### ■ CORDIERITE CERAMICS (2MgO, 2Al<sub>2</sub>O<sub>3</sub>, 5SiO<sub>2</sub>)

Cordierite features a very low thermal expansion coefficient.



# **MANUFACTURING PROCESS**



■RAW MATERIAL MILLING AND MIXING



**■**ISOSTATIC PRESSING



**MACHINING** 



**SPRAY DRYING** 



**DRY PRESSING** 



**■**HOT PRESSING

## **RAW MATERIAL**

**CASTING** 

# **FORMING**



**■**EXTRUSION

### **SINTERING**



**■**SINTERING



**■INJECTION MOLDING** 



**■**SINTERING

### 10







**■GRINDING AND LAPPING** 

# **GRINDING AND BONDING**





**■HIP** (HOT ISOSTATIC PRESSING)

# **INSPECTION**



**■**METALLZING



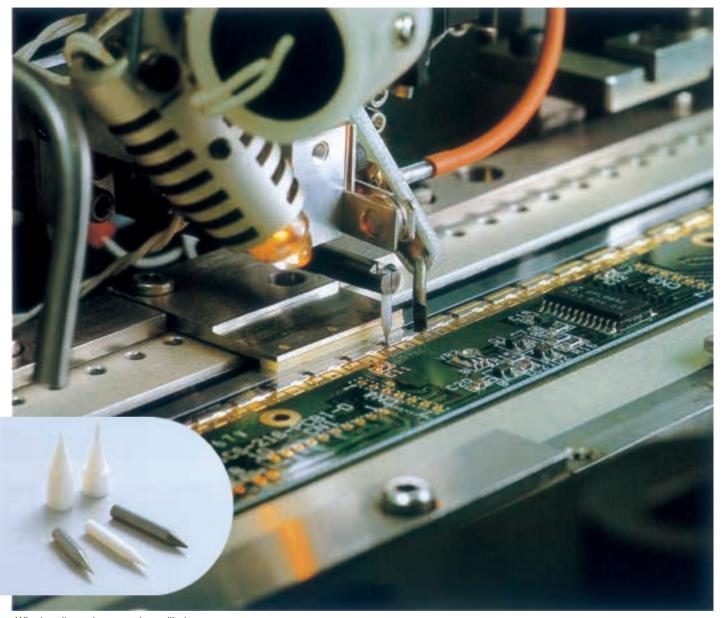
**PRODUCT** 



**■INSPECTION** 



# PRECISION MACHINED PRODUCTS



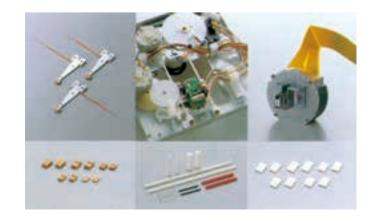
Wire bonding using ceramic capillaries.

### OA equipment parts

As computers increase in memory capacity, floppy and hard disk drives use ceramic sliders that possess superior characteristics and high precision.

With the size reduction and sophistication of OA equipment, ceramic shafts, lighter in weight and with increased wear resistance and precision, are quickly replacing metal shafts.

In meeting the need for greater speed and higher density dot matrix printers, precision ceramic wire guides are used.







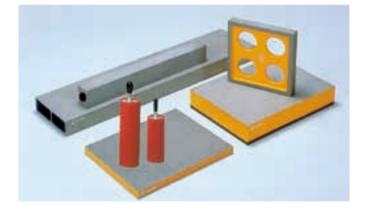
### Wafer polishers

Ceramic plates are used to mount and adhere wafers during finishing to enhance flatness and other surface conditions. Ceramics are also used for the dressing plate.



### Semiconductor processing machine jigs

Superior in chemical, heat and wear resistance, ceramics are used in semiconductor processing machines such as CVD equipment, etching machines and light exposers, to hold, transport and heat-treat wafers.



### Measuring instrument parts

Ceramics are widely used in measuring instruments for their structual and non-corrosive properties. Their hardness prevents gouging, bulging and burring along with consistent precision measurements.



### Fiber optic connectors

Ceramic parts, such as ferrules and sleeves, finished to ultra-precision are used in connectors requiring sub-micron precision.



# CORROSION AND WEAR RESISTANT PARTS



All fine ceramic centrifugal pump used in chemical plants.

### Pump and valve parts

Ceramics are used in pump plungers, magnetic pump shafts and sleeves for superior wear resistance. In ball and faucet valves, ceramics are used to provide excellent sealing quality and wear resistance.







### Medical equipment and chemical analyzer parts

The chemical stability of ceramics permits their application to the artificial kidney pump. Free from corrosion and superior in cleaning properties, ceramic materials are also used in blood valves.



### **Nozzles**

Scrubber nozzles require ceramics excellent chemical and wear resistance. In cleaning nozzles, through which water flows at a high rate, wear resistance is essential ceramics superior heat resistance is utilized in welder and burner nozzles.



### Grinding mill parts

Benefiting from high wear resistance, grinding mills use ceramics for their liners, agitator screws and rollers. Ball mill balls are manufactured from the same materials being milled.



### Food machine parts

The inherent cleanliness and simple cleaning procedures of ceramics are greatly appreciated in kneading rollers, and in parts for filling machines such as valves and pumps.



# WEAR AND HEAT RESISTANT PARTS



Ceramic parts used for paper processing machinery.

### Papermaking parts

Ceramics, superior in wear resistance, are used in cleaner cones separating foreign matter from pulp slurry.







### Molten metal processing parts



### Wire drawing machine parts

To benefit from ceramics wear resistance and light weight, wire drawing machine parts use ceramics in capstan rollers and wire guide rollers.



### Thread guides

Ceramic is used in guide parts for thread processing and oiling nozzles, rollers and twining parts because of its high wear resistance, very low susceptibility to damage by high-speed running of thread, and low friction coefficient.



# **WEAR AND HEAT RESISTANT PARTS**

### Cutters

Of all ceramic materials, zirconia exceeds in strength, toughness and wear resistance, and is used in industrial cutters and slitters to process fiber, paper, film and similar materials. Cermet, which can be brazed and electric charge-processed, is used in cutters and wear resistant precision parts, in combination with metal.



### Physiochemical equipment parts

Superior chemical and heat resistance with no outgasing at high temperatures allow high purity alumina ceramics to be used in analytical equipment.



### Ceramic heaters

Alumina heaters, are manufactured by printing resistors on alumina sheets, then laminating and sintering them into one piece. Silicon nitride heaters are manufactured by printing resistors on silicon nitride or embedding them therein. Ceramic heaters find use in a wide range of industrial fields.



### Living and household appliances

Less subject to rust and more wear resistant than conventional metal, ceramics are used for knives, golf and baseball spikes, clock casings and many other sport and recreational appliances.





# PRECISION SHAPING AND MACHINING

With Kyocera's unique ceramic precision machining technology, formed material is cut, ground and lapped after sintering to required shapes.

These products are used for their unrivaled performance in OA sliding parts as general structural members, precision jigs and tools, in wear and chemical resistant sliding parts and also in electromagnetic fields and chemical solutions.

### **Dimensional precision achieved by machining**

When dimensional precision is required for machined ceramics, Kyocera is capable of achieving the tolerances as shown in the table below. If greater tolerances are required, please consult us.

### **MACHINING DIMENSIONAL PRECISION**

(Data are in mm unless otherwise specified)

1 Ground ceramic blocks and plates

Tolerance Dip.	l Standard	d Tolerance				
Parameter Dimension	<i>φ</i> (□) 5~ <i>φ</i> (□) 30	φ (□) Over 30				
Parallelism	0.02	0.05				
Flatness	0.01	0.03				
Surface Roughness	1.5 <i>μ</i> Ra	1.5 <i>μ</i> Ra				
Mirror Polishing	0.2 <i>μ</i> Ra					

### 2 Round and Square Bars

 $\phi$  100 ( $\Box$ 100)imes 100  $\ell$ 

7 · · · · · · · · · · · · · · · · · · ·	
Tolerance Parameter	Standard Tolerance
Roundness	0.01
Perpendicularity	0.01 (30′)
Straightness	0.05/100
Surface Roughness	1.5 <i>μ</i> Ra

### **PRECISION MACHINED PRODUCTS**

Ultra-precision is possible with Kyocera's unique techniques. Precision machining is affected by shape and material. Some practical examples are shown in the table below.

Parameter  Example of Machining	Dimensions	Material	Dimensional Tolerance ( $\mu$ m)	Round- ness ( $\mu$ m)	Perpendicularity Straightness ( $\mu$ m)	Surface Roughness ( µ Pa)
Inner Diameter	φ 6×L20	AO479S	±3	0.3	0.3	0.2
Inner Diameter	φ 30×L20	AO479O	±3	0.3	0.3	0.3
Outer Diameter	φ 4×L20	AO479O	±1	0.3	0.3	0.3
Outer Diameter	φ 40×L30	AO479S	±1	0.3	0.3	0.3
Plate	φ 40×T5	AO479S	±1	Parallelish 1	Parallelish 1	0.2
riale	φ 100×T5	AO479O	±1	Parallelish 0.3	Parallelish 1	0.1

<sup>\*</sup> Surface roughness depends on the material. The data shown hear indicates where alumina is used.

### **Surface Characteristics**

Kyocera's comprehensive technology, from material control to forming and sintering allows its fine ceramic products excellent surface smoothness and flatness.

### ■SURFACE ROUGHNESS (ALUMINA)

1 As fired (3  $\mu$  Ra)



### 2 Ground (1 µ Ra)



### $\boxed{3}$ Lapped (0.4 $\mu$ Ra)



### 4 Polished (0.2 μ Ra or less)

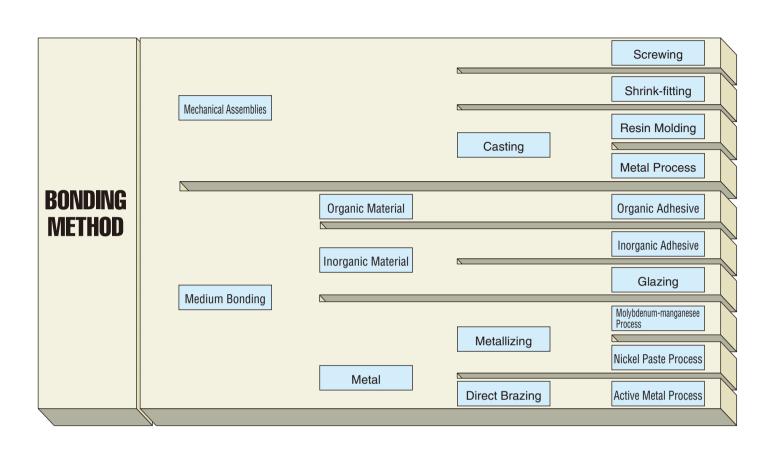


### **■**ROUNDNESS MEASUREMENT





# JOINING CERAMICS TO OTHER MATERIALS



### **Screwing**

Used for junctions subject to strong impact such as in machine mechanisms.



### **Shrink-fitting**

Based on the higher compression resistance and lower thermal expansion of ceramics, it is used to reinforce ceramic pipes subject to internal pressure.



### **Resin molding**

Ceramic parts are inserted and formed into desired shapes.
Simple design is possible.





### **Metal casting**

The thermal shock resistance of silicon carbide is beneficial in metal casting Molten metal (aluminum and zinc) is cast around ceramic material, then formed.



### **Organic adhesive**

Used to bond ceramics and various materials. The method is simple and is applied to parts at room temperature.



### Glazing

Used when special reliability, such as straightness, is required for junctions or when external gas must be kept out or the vacum condition.



### Molybdenum-manganese process

A typical method used to seal ceramics and metal.

Molybdenum-manganese paste is used as metal film is baked on the ceramics surface. The film formed is bonded to metal by high temperature brazing.



### **Nickel paste process**

Nickel paste is used as metal film is baked on the ceramics surface.



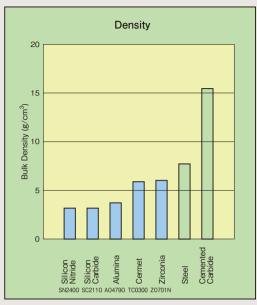
### **Active metal method**

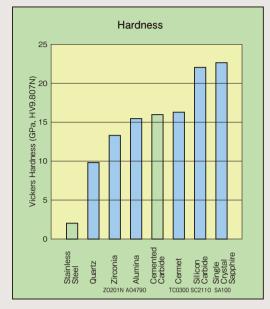
Very active metals, such as titanium, zircon, nickel, copper and silver are inserted between the ceramics and the material to be bonded, then heated in a special atmosphere.

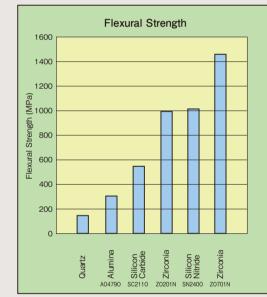


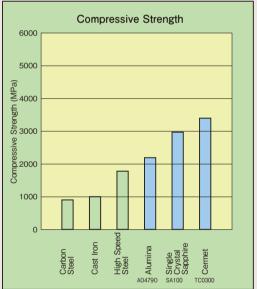


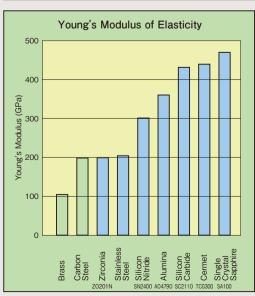
# **MATERIALS COMPARISON CHART**



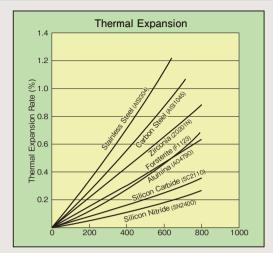


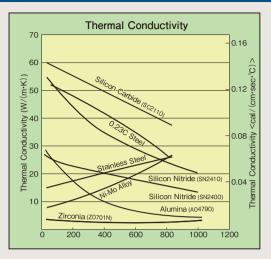


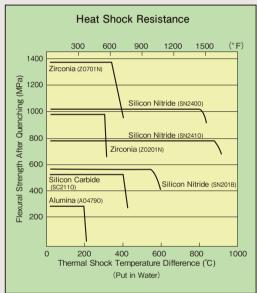


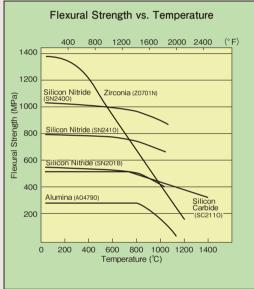


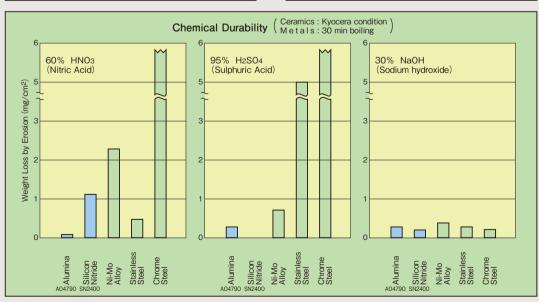












### Unit Conversion Table

-011000			
MPa or N/	mm <sup>2</sup>	kgf/mm <sup>2</sup>	psi(=lbf/in2)
1	1	.020×10 <sup>-1</sup>	1.450×10 <sup>2</sup>
9.807	,	1	1.422×10 <sup>3</sup>
6.895×1	10-3 7	$0.031 \times 10^{-4}$	1

Thermal conductivity								
W/(m • k)	kcal/(m·h·℃)	cal/(cm·sec·℃)						
1	8.600×10 <sup>-1</sup>	2.389×10 <sup>-3</sup>						
1.163	1	2.778×10 <sup>-3</sup>						
4.186×10 <sup>2</sup>	3.600×10 <sup>2</sup>	1						



# CHARACTERISTICS

						,				,		
Ite	em								ALUMINA	A (Al <sub>2</sub> O <sub>3</sub> )		
Ма	aterial Code	(Old)			A482R	A459	A445	A471	A473	A484	A476	A479
Material Code (New)					AO482R	AO459K	AO445O	AO4710	AO473O	AO484O	AO476O	AO479O
Ар	pearance				Porous			1			Dense	
Co	olor				Pink	Russet	Dark Brown	White	White	White	White	White
Co	ontent			(%)	Al <sub>2</sub> 0 <sub>3</sub> 76	89	90	92	92	92	96	99
						High	Mechanical	Strength, Hi	gh Temperatu	ıre Resistanc	e, High Frequ	uency Insulati
Ma	ain Characte	eristics		• High Heat Resistance	Good for Metallizing	● Light Intercepting, ● High Heat Dissipation	● Wear Resistant	Good for Metallizing, Mechanically Strong	Wear     Resistant	Good     Surface     Smoothness	Hard and     Chemically     Stable	
Ma	Main Applications				Welding Nozzle,     Nozzle for Glass Fiber Manufac- turing	● Magnetron	●IC Packages	● Liner ● Pulverizer	IC Multi- Layer     Packages,     Electron- tube     Housing	Wire- Drawing Parts,     Capstans,     Mechanical Seal Rings	Hybrid IC     Substrates	Heat,     Corrosion     and     Wear     Resistant     Parts
De	ensity (*1)		g/cm <sup>3</sup>	JIS R 1634	3.6	3.6	3.8	3.6	3.6	3.6	3.7	3.8
Wa	ater Absorpt	tion	%	JIS C 2141	0.6	0	0	0	0	0	0	0
stics	Vickers Hardn	ess HV9.807N	GPa	JIS R 1610	9.0	12.1	12.7	11.8	12.3	12.3	13.7	15.2
cteris	Flexural Str	ength 3 P.B.	MPa	JIS R 1601	120	310	320	390	340	370	350	310
hara	Compressiv	e Strength	MPa	JIS R 1608	_	-	_	_	2,300	_	_	2,160
cal C	Young's Modul	us of Elasticity	GPa	JIS R 1602	160	280	320	280	280	280	320	360
hanic	Poisson's	s Ratio	_	JIS K 1002	0.17	0.23	0.23	0.23	0.23	0.23	0.23	0.23
Mec	Fracture Toug	hness (SEPB)	MPa·m <sup>1/2</sup>	JIS R 1607	_	_	_	_	_	_	_	3~4
cteristics Mechanical Characteristics	Coefficient of Linear	40 − 400°C	× 10 <sup>-6</sup> /K	JIS R 1618	7.1	7.0	7.3	7.1	6.9	6.8	7.2	7.2
acteri		40 — 800°C	~ 10 /K	010 H 1010	7.5	7.9	8.1	7.9	7.8	7.7	7.9	8.0
Chare	Thermal Conductivity	20℃	W/(m ⋅ K)	JIS R 1611	8	14	12	16	18	17	24	29
mal (	Specific Heat	· · ·	J/(g · K)	JIS R 1611	0.75	0.75	0.75	0.79	0.78	0.78	0.78	0.79
The	Thermal Shock Temperature Differen	(Put in Water, ce Relative Method)	°C	JIS R 1648	320	-	_	200	200	200	200	200
tics	Dielectric	Strength	kV/mm		12	15	12	16	16	14	15	15
eris	Values	20°C			> 10 <sup>14</sup>	> 10 <sup>14</sup>	10 <sup>11</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>
ract	Volume Resistivity	300℃	Ω·cm		10 <sup>10</sup>	10 <sup>10</sup>	10 <sup>7</sup>	10 <sup>12</sup>	10 <sup>12</sup>	10 <sup>10</sup>	10 <sup>10</sup>	10 <sup>10</sup>
Electrical Characteristics Thermal Chara		500℃		JIS C 2141	10 <sup>8</sup>	108	10 <sup>5</sup>	10 <sup>9</sup>	10 <sup>10</sup>	108	10 <sup>8</sup>	10 <sup>8</sup>
cal (	Dielectric Constant	(1MHz)	_		8.4	8.8	9.8	8.9	9.0	8.9	9.4	9.9
ctric	Dielectric Loss Angle	(1MHz)	(×10 <sup>-4</sup> )		180	6	20	6	6	9	4	2
	Loss Facto	or	(×10 <sup>-4</sup> )		1,500	52	190	53	54	80	38	20
Chemical Characteristics	Nitric Acid	60%) 90°C ,24H	(Weight Loss)		_	_	_	_	0.32	0.14	_	0.10
mical	Sulphuric Acid (	95%) 95°C ,24H	mg/cm <sup>2</sup>	_	_	_	_	_	0.65	0.34	_	0.33
Cher	Sodium Hydroxide	(30%) 80°C ,24H	ilig/cili		_	_	_	_	0.91	0.95	_	0.26

The values are typical material properties and may vary according to products configuration and manufacturing process. For more details, Please feel free to contact us. \*1: All values for apparent density and bulk density are the same, except for A482R which lists apparent density only.



			SAPP	HIRE	CORD (2MgO · 2Al		STEATITE (MgO · SiO <sub>2</sub> )		FORSTERITE (2 MgO · SiO <sub>2</sub> )		
A479S	A479M A479G	A480S	A601D A601L	SA1	00	CO220	CO720	S210	S211	F1120	F1023
AO479S	AO479M AO479G	AO480S	AO601D AO601L	SA1	00	CO220O	CO720O	SO210O	SO2110	F1120O	F1023O
				Den	se	Dense	Dense	De	nse	De	nse
lvory	Ivory	Ivory	Ivory	Transp	arent	Gray	Gray	White	Dark Brown	Light	Yellow
99.5	99.5	99.7	99.9	99.9	99	_	_	_	_	_	_
on, High Che	mical Resista	ance		Single (	Crystal	• Very Low T	hermal	Thermal	• Good	• Good	High Thermal
<ul> <li>Hard and Chemically Stable,</li> <li>Fine Grain Strong and Smooth</li> </ul>	High Chemical Resistance,	<ul><li>Good Anti-F</li><li>Wear Resist</li><li>High Purity</li></ul>		High Heat     Resistance,     High Chemical     Resistance		Expansion • Light Weight  • Void Less		Insulator	Light Shield	Surface Finish	Expansion
●Pump ●Shafts	ofts      Chemically Ressitant Parts     Semiconductor Processing     Chemically Ressitant Parts     Chemically Ressitant Parts		<ul><li>Windows,</li></ul>	Chemically Resistant     Wafer Inspection		t Circuit ection Stage Parts			• Substrate For Resistor • Core For Resistor		
3.9	3.9	3.9	3.9	3.9	7	2.5	2.5	2.8	3.1	3.0	3.0
0	0	0	0	0		0	0	0	0	0	0
16.0	15.7	17.2	17.5	Surface a	22.5	8	8.5	5.8	6.7	7.3	5.9
360	370	380	400	Surface a Axis c	690	190	200	190	220	180	160
2,350		_	_	2,9	40	_	_	-	_	_	_
370	370	380	380	47	0	140	145	120	130	150	150
0.23	0.23	0.23	0.23	_		0.31	0.31	0.22	0.22	0.24	0.24
4	_	_	5~6	_		1 ~ 1.5	1 ~ 1.5	-	_	_	_
7.2	7.2	7.2	7.2	Parallel to Axis c	7.7	1.5 (40°C~400°C) 2.1 (40°C~800°C)	1.5 (40°C~400°C) 2.1 (40°C~800°C)	7.7	9.2	9.7	10.1
8.0	8.0	8.0	8.0	Vertical to Axis c	7.0	<   0.05   (23°C) <   0.02   (22°C)	<   0.05   (23°C) <   0.02   (22°C)	8.0	10.4	_	_
32	32	32	34	41		4	4	2	3	5	5
0.78	0.78	0.79	0.78	0.7	5	0.71	_	0.75	0.72	0.78	0.75
250	_	_	_	_		_	400	_	_	_	_
15	15	15	15	48	3	19.1	19.3	18	14	17	13
> 10 <sup>14</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>	> 1	014	> 10 <sup>14</sup>	>10 <sup>14</sup>	> 10 <sup>14</sup>	> 10 <sup>13</sup>	> 10 <sup>14</sup>	> 10 <sup>14</sup>
10 <sup>13</sup>	10 <sup>13</sup>	10 <sup>13</sup>	10 <sup>13</sup>	_		10 <sup>12</sup>	10 <sup>12</sup>	10 <sup>10</sup>	10°	10 <sup>13</sup>	10°
10 <sup>10</sup>	10 <sup>10</sup>	10 <sup>10</sup>	10 <sup>10</sup>	10		10 <sup>10</sup>	10 <sup>10</sup>	10 <sup>7</sup>	10 <sup>7</sup>	10 <sup>10</sup>	10°
9.9	9.9	9.9	9.9	Parallel to Axis c Vertical to Axis c	11.5 9.3	4.9	4.9	6	8	6.5	6.5
1	1	1	1	<	1	9	8.5	18	750	3	5
10	10	10	10	_		_	_	108	6,000	20	30
0.07	_	0.05	0.03	<b>≑</b> 0	.00	_	_	-	_	_	_
0.25	_	0.22	0.19	<b>≑</b> 0	.00	_	_	-	_	_	_
0.05	_	0.04	0.03	<b>≑</b> 0	.00	_	_	-	_	_	_
41	$_{\rm uf/mm^2} - 0.8$	07140	4 1// -	m·sec·°C	1100	\A/// \/\					

 $1 \text{kgf/mm}^2 = 9.807 \text{MPa}$ 

 $1cal/(cm \cdot sec \cdot ^{\circ}C) = 418.6W/(m \cdot K)$ 



# CHARACTERISTICS

				Matadal	VTTDIA				011 10 0 11	OADDIDE	01	
Ite	em			Material	YTTRIA (Y <sub>2</sub> O <sub>3</sub> )		TITANIA		SILICON (S	CARBIDE iC)	SI	
М	aterial Code (C	Old)			YO100A	T716	T716H	T792H	SC211	SC1000	SN201B	
М	aterial Code (N	lew)			YO100A	TO7160	TO716H	TO792H	SC2110	SC1000	SN201B	
Ap	opearance				Dense		Dense		De	nse		
Co	olor				White	Light Brown	Light Brown	Grayish Yellow	Black	Black	Black	
Co	ontent			(%)	_	-	-	-	-	_	_	
M	ain Characteri	in Characteristics		naracteristics		• Good Plasma Resistance	Goo • CaTiO₃	od Surface F	•BaTiO₃	<ul> <li>High Temp Strength</li> <li>High Cher Resistanc Thermal</li> <li>Conductive</li> </ul>	mical e, Excellent	
					•SPE Parts	• Slider Pag	de for Diek F	Drive Heads	• Fracture Toughness	Chemical Resistance		
M	• SPE Parts  • Slider Pads for Disk Drive Heads • High Temperature Resistance Parts					perature						
De	ensity (*1)		g/cm <sup>3</sup>	JIS R 1634	4.9	3.9	4.0	4.5	3.2	3.16	3.2	
	ater Absorptio	n	%	JIS C 2141	0	0	0	0	0	0	0	
stics	Vickers Hardness HV9.807N		GPa	JIS R 1610	6.0	8.5	8.8	8.1	22.0	23.0	13.9	
cteri	Flexural Streng	gth 3 P.B.	MPa	JIS R 1601	130	320	320	230	540	450	580	
hara	Compressive Strength		MPa	JIS R 1608	-	-	_	-	-	_	-	
cal C	Young's Module	us of Elasticity	GPa	JIS R 1602	160	260	270	180	430	440	290	
hani	Poisson's I	Ratio	_	010 11 1002	-	-	_	_	0.16	0.17	0.28	
Mec	Fracture Toughne	ess (SEPB)	MPa·m <sup>1/2</sup>	JIS R 1607	1.1	-	_	_	4~5	2~3	4~5	
cteristics Mechanical Characteristics	Coefficient of Linear	40 — 400°C	400℃ × 10 <sup>-6</sup> /K JIS R 1		7.2	11.5	11.5	9.6	3.7	3.7	2.4	
acter	Thermal Expansion	nermal kpansion 40 − 800°C		310 11 1010	7.6	12.1	12.1	_	4.4	4.4	3.2	
Chara	Thermal Conductivity	20℃	W/(m ⋅ K)	JIS R 1611	14	4	4	2	60	200	25	
Thermal	Specific Heat Ca	• •	J/(g · K)	JIS R 1611	0.45	0.71	0.71	0.59	0.67	0.67	0.64	
	Thermal Shock Temperature Difference	(Put in Water, e Relative Method)	တ	JIS R 1648	-	-	_	_	400	_	550	
tics	Dielectric St	trength	kV/mm		11	-	_	_	_	_	_	
eris	Volume	20℃			>10 <sup>13</sup>	1012	1012	10 <sup>12</sup>	10 <sup>5</sup>	10 <sup>8</sup>	>10 <sup>14</sup>	
ract	Volume Resistivity	300℃	Ω·cm		10 <sup>10</sup>	-	_	-	10 <sup>4</sup>	10 <sup>4</sup>	1012	
Chai		500℃		JIS C 2141	10 <sup>7</sup>	-	_	-	10 <sup>3</sup>	10³	10 <sup>10</sup>	
Electrical Characteristics	Dielectric Constant	(1MHz)	_		11	-	-	_	-	_	-	
ctric	Dielectric Loss Angle (1MHz)		(×10 <sup>-4</sup> )		5	-	_	_	-	_	_	
	Loss Factor		(×10 <sup>-4</sup> )		55	_	_	_	_	_	_	
stics	Nitric Acid (60	%)90℃ ,24H	(Moight Locs)		_	_	_	_	0.04	<b>⇒</b> 0.00	_	
Chemical Characteristics	Sulphuric Acid (	95%) 95°C ,24H	(Weight Loss)	_	_	_	_	_	0.01	<b>÷</b> 0.00	_	
Chen	Caustic Soda (30%) 80°C ,24H		mg/cm <sup>2</sup>		_	-	_	_	<b>⇒</b> 0.00	<b>÷</b> 0.00	-	

The values are typical material properties and may vary according to products configuration and manufacturing process. For more details, Please feel free to contact us. \*1: All values for apparent density and bulk density are the same, except for A482R which lists apparent density only.



LICON NITRII (Si <sub>3</sub> N <sub>4</sub> )	DE	ALUMINIU (A)	M NITRIDE	ZIRCONIA (ZrO <sub>2</sub> )				CERMET	
SN240	SN241	AN216A	AN2000	Z220	Z201N	Z701N	Z21H04	TC30	
SN2400	SN2410	AN216A	AN2000	Z02200	ZO201N	Z0701N	Z21H04	TC0300	
Dense		Dei	nse		De	nse		Dense	
Black	Black	Gray	Ivory	Yellow	lvory	Ash Black	Black	Silver	
-	_	_	A&N 99.9	-	_	_	_	_	
<ul> <li>High Temper:</li> <li>Wear Resista</li> <li>Excellent The Resistance</li> <li>Light Weight</li> </ul>	ınt	High Electrical Insulation,     High Thermal Conductivity      Excellent Thermal High Purity,		•	<ul> <li>High Mechanical Strength,</li> <li>Excellent Wear Resistance,</li> <li>Good Surface Finish,</li> <li>High Fracture Toughness</li> </ul>				
Haigh     Strength, High     Temperature     Durability	High Thermal Conductivity	Conductivity	• Good Plasma Resistance					Resistance, • Electrical Conductivity	
Anti Wear Line     Powder Equip     Molten Metal F     Metal Forming	Heat Unifor Parts,     High Temp Treatment     Semicond Processin Equipment	perature Fixtures, Juctor	•	Pump Parts, Dies Cutting Blades, S Club Faces, Scis:	Spikes.		Outting Tool Tips, Wear Resistant Parts, Metal Forming Tools		
3.3	3.2	3.4	3.2	5.6	6.0	6.0	5.6	6.0	
0	0	0	0	0	0	0	0	0	
14.0	13.8	10.4	11.2	10.7	12.3	12.7	10.8	16.2	
1,020	790	310	220	750	1,000	1,470	710	1,470	
-	-	_	_	_	_	-	_	3,430	
300	290	320	310	200	200	220	210	440	
0.28	0.28	0.24	0.24	0.31	0.31	0.31	_	0.21	
7	6 ~ 7	_	_	7 ~ 8	4~5	4~5	3~4	_	
2.8	2.9	4.6	4.6	10	10.5	10.8	10.3	7.4	
3.3	3.5	5.3	5.2	10.5	11.0	11.3	11.4	8.3	
27	54	150	67	3	3	3	3	17	
0.65	0.66	0.71	0.72	0.46	0.46	0.46	0.48	_	
800	900	_	_	450	300	350	_	310	
13	12	14	16	13	11	-	-	_	
>10 <sup>14</sup>	>10 <sup>14</sup>	>1014	>1014	>10 <sup>14</sup>	10 <sup>13</sup>	-	10 <sup>8</sup>	10⁻⁴	
10 <sup>12</sup>	10 <sup>12</sup>	10 <sup>10</sup>	10 <sup>11</sup>	10 <sup>6</sup>	10 <sup>6</sup>	_	_	_	
10 <sup>10</sup>	10 <sup>10</sup>	108	10 <sup>9</sup>	10 <sup>4</sup>	10 <sup>3</sup>	_	_	_	
9.6	9.6	8.6	8.5	28	33	_	_	_	
19	18	3	2	17	16	_	-	_	
_	_	26	17	476	520	_	_	_	
1.11	0.18	_	_	-	≑ 0.00	≑ 0.00	-	6.0	
0	0	_	_	_	0.04	0.04	-	0.26	
0.22	0.07	_	_	-	0.08	0.08	-	0.02	

 $1 \text{kgf/mm}^2 = 9.807 \text{MPa} \qquad \qquad 1 \text{cal/(cm} \cdot \text{sec} \cdot ^{\circ}\text{C}) \ = 418.6 \text{W/(m} \cdot \text{K)}$ 



### <JAPAN: Headquarters> **KYOCERA Corporation**

### **Corporate Fine Ceramics Group**

6 Takeda Tobadono-cho, Fushimi-ku, Kyoto 612-8501, Japan Tel: +81-(0)75-604-3441 Fax: +81-(0)75-604-3438

### K

WEB

### global.kyocera.com/prdct/fc/index.html

#### <U.S.A.>

#### KYOCERA International, Inc.

#### San Jose, CA

49070 Milmont Dr. Fremont, CA 94538 Tel:+1-510-257-0200 Fax:+1-510-257-0125

#### San Diego, CA

8611 Balboa Avenue, San Diego, CA 92123 Tel:+1-858-614-2520 Fax:+1-858-715-0871

#### Chicago, IL

25 NW Point Blvd., #660 Elk Grove Village, IL 60007 Tel:+1-847-981-9494 Fax:+1-847-981-9495

24 Superior Dr, Suite 106, Natick, MA 01760 Tel: +1-508-651-8161 Fax: +1-508-655-9139

#### Mountain Home, NC

100 Industrial Park Rd, Hendersonville, NC 28792 Tel:+1-828-693-8244 Fax:+1-828-692-1340

#### New Jersey, NJ

220 Davidson Ave., Suite108, Somerset, NJ 08873 Tel:+1-732-563-4336 Fax:+1-732-627-9594

7801 Capital of Texas Highway, Ste 330 Austin, TX 78731 Tel:+1-512-336-1725 Fax:+1-512-336-8189

### Vancouver, WA

5713 East Fourth Plain Blvd., Vancouver, WA 98661 Tel:+1-360-696-8950 Fax:+1-360-696-9804

### <EUROPE>

### **KYOCERA Fineceramics GmbH**

### Esslingen, Germany

Fritz-Mueller-Strasse 27, 73730 Esslingen, Germany Tel:+49-(0)711-93934-0 Fax:+49-(0)711-93934-950

### Neuss, Germany

Hammfelddamm 6 41460 Neuss, Germany Tel:+49-(0)2131-1637-0 Fax:+49-(0)2131-1637-150

### KYOCERA Fineceramics Ltd.

### U.K.

Prospect House, Archipelago, Lyon Way, Frimley, Surrey GU16 7ER, U.K.

Tel:+44-(0)1276-6934-50 Fax:+44-(0)1276-6934-60

### KYOCERA Fineceramics S.A.S.

### France

Parc Tertiaire, Silic, 21 Rue De Villeneuve BP 90439 94583 Rungis Cedex, France Tel:+33-(0)141-7373-30 Fax:+33-(0)141-7373-59

#### <ASIA>

#### KYOCERA Korea Co., Ltd.

2F MYUNGIN-TOWER, 267 Hyoryeong-Ro Seocho-Gu, Seoul, 06653, Korea Tel: +82-(2)-3463-3538 Fax: +82-(2)-3463-3539

### KYOCERA (China) Sales & Trading Corporation Shanghai

Floor 9, Dushi Headquarters Building, No. 168, Middle Xizang Road, Shanghai, 200001

Tel: +86-(0)21-5877-5366 Fax: +86-(0)21-5888-5096

#### Shenzen

Unit 06-08,29/F,AVIC Center NO.1018 Huafu Road, Futian District, Shenzhen, Guangdong, 518033 Tel: +86-(0)755-8272-4107 Fax: +86-(0)755-8279-0487

### KYOCERA (Hong Kong) Sales & Trading Ltd.

#### Hong Kong

Room 801-802, Tower 1, South Seas Centre, 75 Mody Road, Tsimshatsui East, Kowloon, Hong Kong Tel: +852-(0)2722-3912 Fax: +852-(0)2724-4501

### KYOCERA Asia Pacific, Ltd.

### Taiwan

8FL., No.101, Sec.2, Nanjing East Road, Taipei 10457, Taiwan Tel:+886-(0)2-2567-2008 Fax:+886-(0)2-2567-2700

### Singapore

298 Tiong Bahru Road, #13-03/05 Central Plaza, 168730, Singapore Tel:+65-6271-0500 Fax:+65-6271-0600

### **Philippines**

11B, Kingston Tower, Block 2, Lot 1, Acacia Avenue, Madrigal Business Park, Alabang, Muntinlupa City 1780, Philippines Tel:+63-(0)2-771-0618 Fax:+63-(0)2-775-0532

### KYOCERA Asia Pacific (Thailand) Co., Ltd.

1 Capital Work Place, Building 7th Floor, Soi Chamchan, Sukhumvit 55 Road, Klongton Nua, Wattana, Bangkok 10110, Thailand. Tel: +66-(0)2030-6688 Fax: +66-(0)2030-6600

### KYOCERA Sdn. Bhd.

### Malavsia

Lot 4A, Lower Level 3, Hotel Equatrial, Penang No.1, Jalan Bukit Jambul 11900 Penang, Malaysia Tel: +60-4-641-4190 Fax: +60-4-641-4209

### KYOCERA Asia Pacific India Pvt. Ltd.

### India

1004A & 1004B, 10th Floor, JMD Regent Square, M.G. Road Gurugram Haryana,

Tel: +91-124-4714298 Fax: +91-124-4683378

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